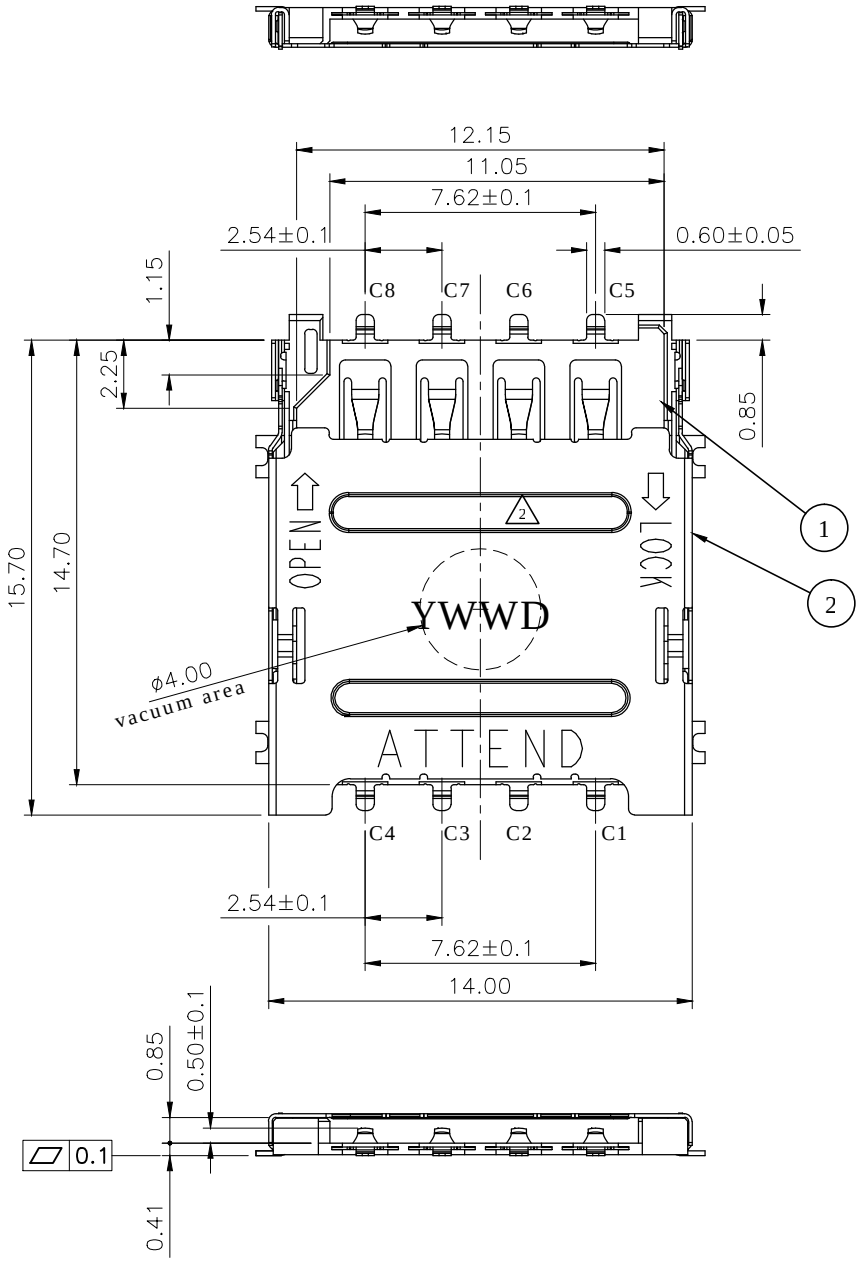
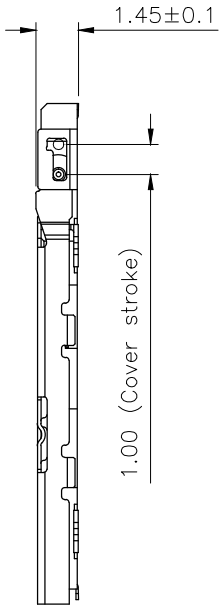
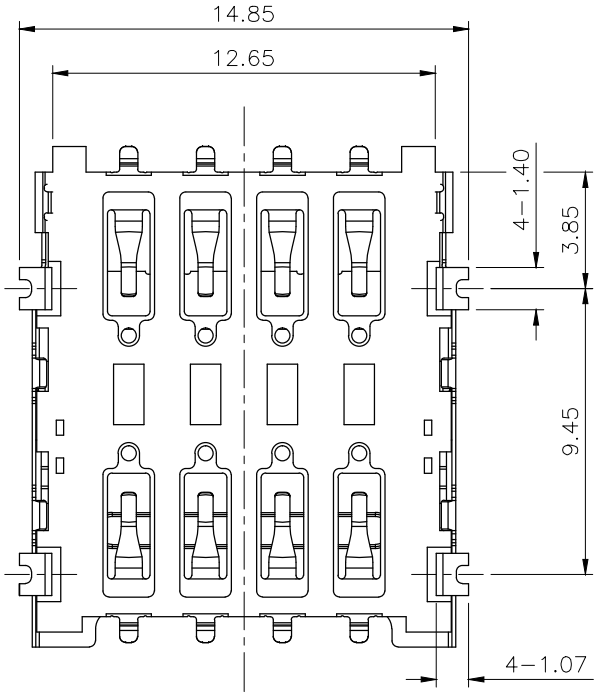
REV.	DESCRIPTION	DRAWN	DATE
1	INITIAL RELEASE	FROS	2015/02/09
2	Add date code	FROS	2016/08/09
3	ECR2300002	FROS	2023/01/10







NO.	PART NAME	DESCRIPTION
2	SHELL	Stainless 0.12T, 50u" Nickel Plated
1	MOLDING	Housing: LCP, Black
		Ground: Stainless 0.15T, Gold Flash
		Contact: Copper Alloy 0.08T, 5u" Gold Plated

UNLESS OTHERWISE SPECIFIED TOLERANCE

UNIT:	DECIMAL	LINEAR	ANGLES
m m	X.	±0.50	±5°
	X.X	±0.25	±3°
	X.XX	±0.12	±1°

ATTEND

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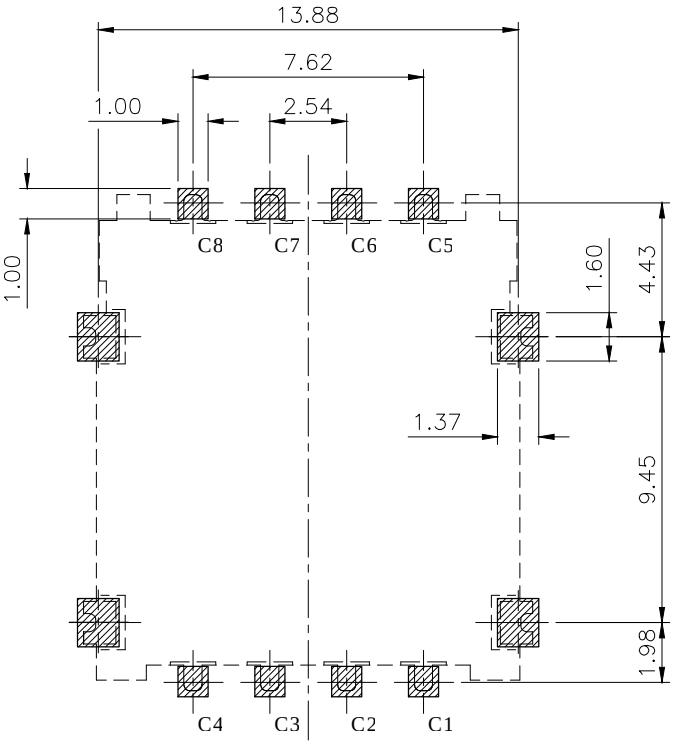
DRAWN	Fros	2014/12/27
CHECKED	Ron	2014/12/27
APPROVED	Albert	2014/12/27

DRAWN NAME: Micro SIM Card Socket, Hinge Type, 8 Pin, 5u" Gold Plating

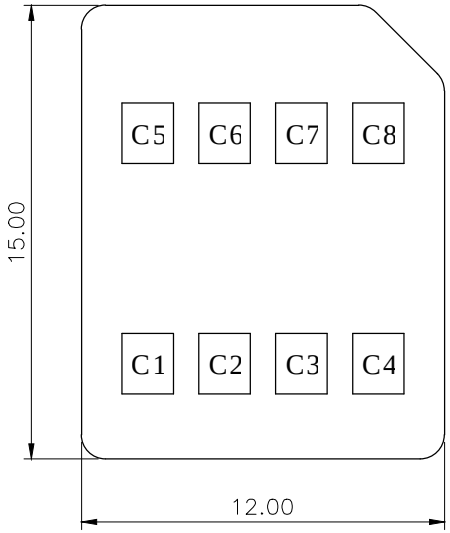
SCALE	SHEET	SIZE	PRODUCT NO.	115R-BCA0
4/1	1/4	A4	FILE NAME	115R-BCA0_B_3

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REV.	DESCRIPTION	DRAWN	DATE
	SEE SHEET 1		



RECOMMEND LAYOUT (TOP VIEW)
GENERAL TOLERANCE ±0.05mm



MICRO SIM CARD
PAD LAYOUT

SPECIFICATION:

1. ELECTRICAL
1.1 Current Rating: 0.5A Max.
1.2 Voltage Rating: 10V AC/DC
1.3 Contact Resistance:
Initially 50mΩ Max.
Finally 100mΩ Max.
1.4 Insulation Resistance: 1,000MΩ Min.
1.5 Dielectric Withstanding Voltage: 500V AC

2. MECHANICAL
2.1 Contact Normal Force: 0.3N Min./ Pin
2.2 Durability: 50 Cycles

3. ENVIRONMENTAL
3.1 Operating temperature range: -40°C~+85°C
3.2 Storage temperature range: -40°C~+85°C
3.3 Storage Humidity: +10%~+80% RH

4. SOLDER ABILITY
4.1 Recommended IR Reflow(Wave Soldering)
Temperature: 260℃

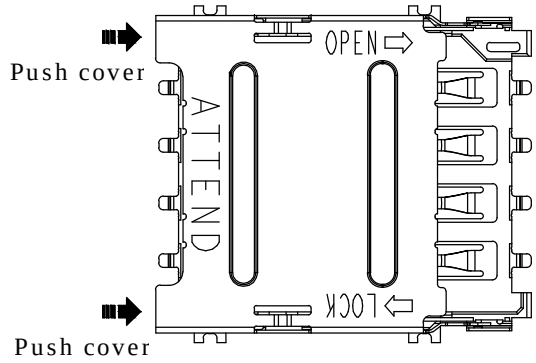
PIN NO.	FUNCTION
C1	VCC
C2	RST
C3	CLK
C4	RFU
C5	GND
C6	VPP
C7	I/O
C8	RFU

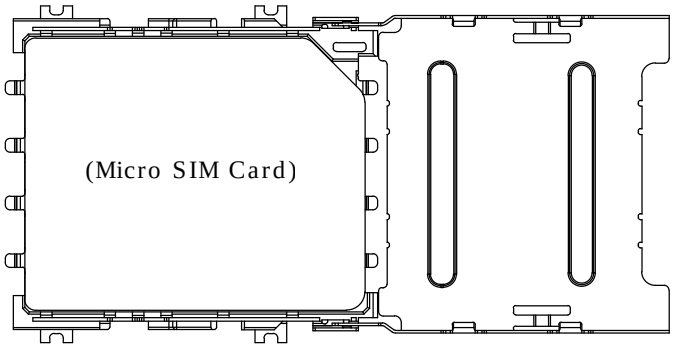
UNLESS OTHERWISE SPECIFIED TOLERANCE				
UNIT: mm	DECIMAL	LINEAR	ANGLES	ATTEND
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	X.X	±0.25	±3°	
	X.XX	±0.12	±1°	WWW.ATTEND.COM.TW

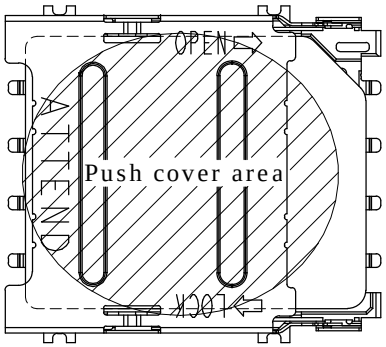
DRAWN	Fros	2014/12/27	DRAWN NAME:	Micro SIM Card Socket, Hinge Type, 8 Pin, 5u" Gold Plating
CHECKED	Ron	2014/12/27		
APPROVED	Albert	2014/12/27	PRODUCT NO.	115R-BCA0
	SCALE 4/1	SHEET 2/4	SIZE A4	FILE NAME 115R-BCA0_B_3

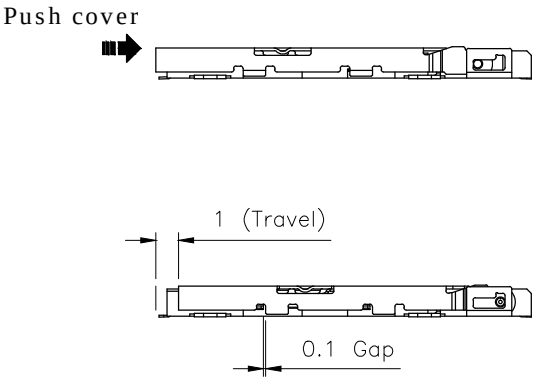
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REV.	DESCRIPTION	DRAWN	DATE
	SEE SHEET 1		

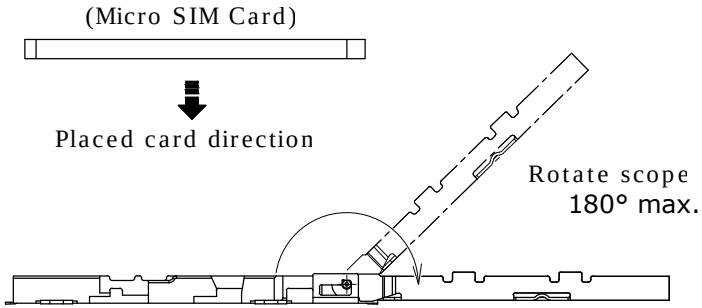




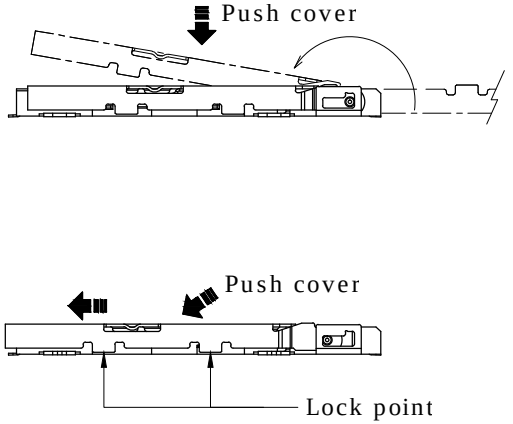




Step 1. Un-Lock



Step 2. Open the cover then add card



Step 3. Close & Lock

UNLESS OTHERWISE SPECIFIED TOLERANCE			
UNIT: mm	DECIMAL	LINEAR	ANGLES
	X.	±0.50	±5°
	X.X	±0.25	±3°
	X.XX	±0.12	±1°

ATTEND

WWW.ATTEND.COM.TW

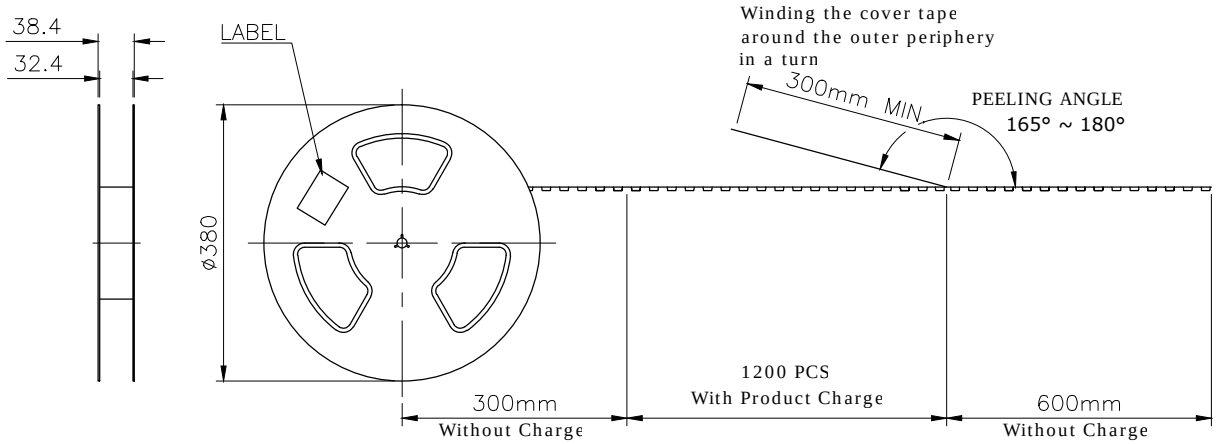
DRAWN	Fros	2014/12/27
CHECKED	Ron	2014/12/27
APPROVED	Albert	2014/12/27

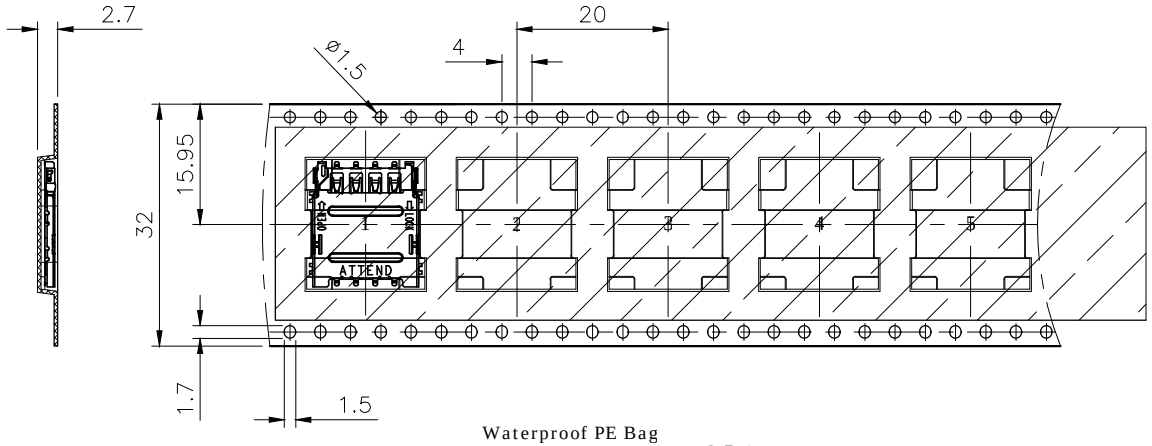
DRAWN NAME: Micro SIM Card Socket, Hinge Type, 8 Pin, 5u" Gold Plating

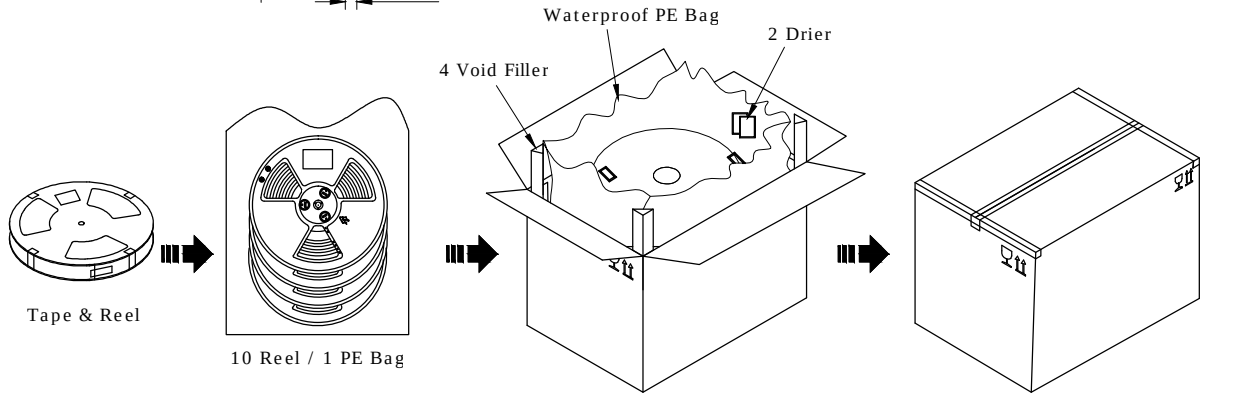
SCALE	SHEET	SIZE	PRODUCT NO.	115R-BCA0
3/1	3/4	A4	FILE NAME	115R-BCA0_B_3

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REV.	DESCRIPTION	DRAWN	DATE
	SEE SHEET 1		







PACKAGING SPECIFICATION:

1. MATERIAL
1.1 Embossed Carrier Tape: PS Black
1.2 Top Cover Tape: PET
20-130g (Peel Speed 300mm/Minute)
1.3 Taping Reel: Plastic

2. PACKING
2.1 Quantity:
1,200 Piece/Reel
10 Reel/PE Bag
12,000 Piece/Carton
2.2 Connector Weight: 0.36g
2.3 Net Weight: 4.32 Kg
2.4 Gross Weight: 13 Kg/Carton

UNLESS OTHERWISE SPECIFIED TOLERANCE				ATTEND
UNIT: mm	DECIMAL	LINEAR	ANGLES	
	X.	±0.50	±5°	
	X.X	±0.25	±3°	
	X.XX	±0.12	±1°	WWW.ATTEND.COM.TW
DRAWN	Fros	2014/12/27	DRAWN NAME: Micro SIM Card Socket, Hinge Type, 8 Pin, 5u" Gold Plating	
CHECKED	Ron	2014/12/27		
APPROVED	Albert	2014/12/27	PRODUCT NO.	115R-BCA0
	SCALE 1/1	SHEET 4/4	SIZE A4	FILE NAME 115R-BCA0_B_3

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